



SBOS147A - SEPTEMBER 1986 - JULY 2005

Fast-Settling FET-Input INSTRUMENTATION AMPLIFIER

FEATURES

● LOW BIAS CURRENT: 50pA max ● FAST SETTLING: 4µs to 0.01%

● HIGH CMR: 106dB min; 90dB at 10kHz INTERNAL GAINS: 1, 10, 100, 200, 500 VERY LOW GAIN DRIFT: 10 to 50ppm/°C

● LOW OFFSET DRIFT: 2μV/°C

LOW COST

PINOUT SIMILAR TO AD524 AND AD624

APPLICATIONS

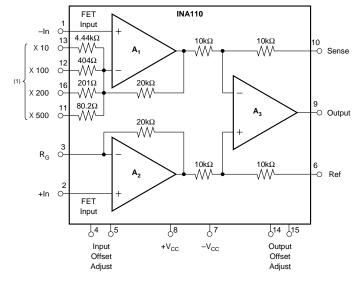
- MULTIPLEXED INPUT DATA **ACQUISITION SYSTEM**
- FAST DIFFERENTIAL PULSE AMPLIFIER
- HIGH SPEED GAIN BLOCK
- AMPLIFICATION OF HIGH IMPEDANCE **SOURCES**

DESCRIPTION

The INA110 is a versatile monolithic FET-input instrumentation amplifier. Its current-feedback circuit topology and laser trimmed input stage provide excellent dynamic performance and accuracy. The INA110 settles in 4µs to 0.01%, making it ideal for high speed or multiplexed-input data acquisition systems.

Internal gain-set resistors are provided for gains of 1, 10, 100, 200, and 500V/V. Inputs are protected for differential and common-mode voltages up to ±V_{CC}. Its very high input impedance and low input bias current make the INA110 ideal for applications requiring input filters or input protection circuitry.

The INA110 is available in 16-pin plastic and ceramic DIPs, and in the SOL-16 surface-mount package. Military, industrial and commercial temperature range grades are available.



NOTE: (1) Connect to R_G for desired gain.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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ABSOLUTE MAXIMUM RATINGS(1)

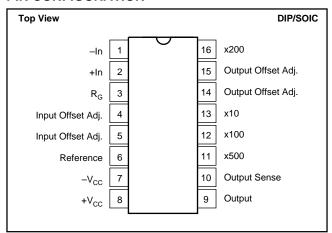
| Supply Voltage | |
|---|----------------------|
| Operating Temperature Range: G | |
| P, U | 25°C to +85°C |
| Storage Temperature Range: G | 65°C to +150°C |
| P, U | 40°C to +85°C |
| Lead Temperature (soldering, 10s): G, P | +300°C |
| (soldering, 3s): U | +260°C |
| Output Short Circuit Duration | Continuous to Common |

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.

PACKAGE/ORDERING INFORMATION

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

PIN CONFIGURATION





ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



ELECTRICAL CHARACTERISTICS

At +25°C, $\pm V_{CC}$ = 15VDC, and R_L = 2k Ω , unless otherwise specified.

| | INA110AG | | | | | A110BG, | SG | IN | NA110KP, | KU | |
|---------------------------------------|---|-----------|------------------------|---------|----------|------------------------|---------|-----|----------|----------|---------------------------|
| PARAMETER | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| GAIN | | | | | | | | | 1 | | |
| Range of Gain | | 1 | | 800 | * | | * | * | | * | V/V |
| Gain Equation ⁽¹⁾ | | | * | | G = 1 - | F [40k/(R _G | + 50Ω)] | | * | | V/V |
| Gain Error, DC: G = 1 | | | 0.002 | 0.04 | | * | 0.02 | | * | * | % |
| G = 10 | | | 0.01 | 0.1 | | 0.005 | 0.05 | | * | * | % |
| G = 100 | | | 0.02 | 0.2 | | 0.01 | 0.1 | | * | * | % |
| G = 200 | | | 0.04 | 0.4 | | 0.02 | 0.2 | | * | * | % |
| G = 500 | | | 0.1 | 1 | | 0.05 | 0.5 | | * | * | % |
| Gain Temp. Coefficient: G = 1 | | | ±3 | ±20 | | * | ±10 | | * | | ppm/° |
| G = 10 | | | ±4 | ±20 | | ±2 | ±10 | | * | | ppm/° |
| G = 100 | | | ±6 | ±40 | | ±3 | ±20 | | * | | ppm/° |
| G = 200 | | | ±10 | ±60 | | ±5 | ±30 | | * | | ppm/° |
| G = 500 | | | ±25 | ±100 | | ±10 | ±50 | | * | | ppm/° |
| Nonlinearity, DC: G = 1 | | | ±0.001 | ±0.01 | | ±0.0005 | ±0.005 | | * | * | % of F |
| G = 10 | | | ±0.002 | ±0.01 | | ±0.001 | ±0.005 | | * | * | % of F |
| G = 100 | | | ±0.004 | ±0.02 | | ±0.002 | ±0.01 | | * | * | % of F |
| G = 200 | | | ±0.006 | ±0.02 | | ±0.003 | ±0.01 | | * | * | % of F |
| G = 500 | | | ±0.01 | ±0.04 | | ±0.005 | ±0.02 | | * | * | % of F |
| OUTPUT | | | | | | | | | | | |
| | Over Temperature | +10 | ±12.7 | | * | * | | * | * | | V |
| Voltage, $R_L = 2k\Omega$ Current | Over Temperature Over Temperature | ±10 ±5 | ±12.7 ±25 | | * | * | | | * | | mA |
| Short-Circuit Current | Over remperature | _ ±5 | ±25 ±25 | | | * | | | * | | 1 |
| Capacitive Load | Stability | | 5000 | | | * | | | * | | mA pF |
| · · · · · · · · · · · · · · · · · · · | Stability | | 3000 | | | | | | | | pΓ |
| INPUT OFFSET VOLTAGE(2) | | | | | | | | | | | |
| Initial Offset: G, P | | | | ±(500 + | | ±(50 + | ±(250 + | | * | * | μV |
| | | | 1000/G) | 5000/G) | | 600/G) | 3000/G) | | | | |
| U | | | | | | | | | , | ±(1000 + | μV |
| | | | | | | | | | 2000/G) | 5000/G) | |
| vs Temperature | | | ±(2 + | ±(5 + | | ±(1 + | ±(2 + | | * | | μV/°C |
| | | | 20/G) | 100/G) | | 10/G) | 50/G) | | | | |
| vs Supply | $V_{CC} = \pm 6V \text{ to } \pm 18V$ | | ±(4 + | ±(30 + | | ±(2 + | ±(10 + | | * | * | μV/V |
| | | | 60/G) | 300/G) | | 30/G) | 180/G) | | | | |
| BIAS CURRENT | | | | | | | | | | | |
| Initial Bias Current | Each Input | | 20 | 100 | | 10 | 50 | | * | * | pА |
| Initial Offset Current | · ' | | 2 | 50 | | 1 | 25 | | * | * | pA |
| Impedance: Differential | | | 5x10 ¹² 6 | | | * | | | * | | Ω p |
| Common-Mode | | | 2x10 ¹² 1 | | | * | | | * | | Ω pl |
| VOLTAGE RANGE | V _{IN} Diff. = 0V ⁽³⁾ | | ** | | | | | | | | |
| Range, Linear Response | VIN DIII. = OV | ±10 | ±12 | | | | | * | * | | l v |
| CMR with 1kΩ Source Imbalance: | | 1 -10 | 112 | | | | | | | | l v |
| G = 1 | DC | 70 | 90 | | | 100 | | * | * | | dB |
| G = 1 G = 10 | DC DC | 87 | 104 | | 80 96 | 112 | | | * | | dB |
| G = 10 G = 100 | DC | 100 | 1104 | | 106 | 112 | | | * | | dB |
| | DC | | | | | 1 | | | * | | dB |
| G = 200 | DC | 100 | 110 | | 106 | 116 | | * | * | | |
| G = 500 | DC | 100 | 110 | | 106 | 116 | | | | | dB |
| INPUT NOISE(4) | | | | | | | | | | | l _ |
| Voltage, f _O = 10kHz | | | 10 | | | * | | | * | | nV/√F |
| $f_B = 0.1Hz$ to $10Hz$ | | | 1 | | | * | | | * | | μV _{PF} fA/√H |
| Current, f _O = 10kHz | | | 1.8 | | | * | | | * | | fA/√H |
| OUTPUT NOISE(4) | | | | | | | | 1 | | | |
| Voltage, $f_0 = 10kHz$ | | | 65 | | I | * | | I | * | | nV/√H |
| $f_B = 0.1Hz \text{ to } 10Hz$ | | | 8 | | | * | | l | * | | μV _{PP} |
| - | | | | | | | | | + | | |
| DYNAMIC RESPONSE | 040 | | 2.5 | | | * | | | * | | NAL I |
| Small Signal: G = 1 | –3dB | 1 | 2.5 | | l | . | | l | | | MHz |
| G = 10 | | | 2.5 | | | . | | | 1 | | MHz |
| G = 100 | | | 470 | | |] | | 1 | | | kHz |
| G = 200 | | 1 | 240 | | l |] | | l | 1 | | kHz |
| G = 500 | 1/ 1/01/ | 1 | 100 | | l | _ | | l | | | kHz |
| Full Power | $V_{OUT} = \pm 10V$, | 1 | | | _ | _ | | l | | _ | |
| a | G = 2 to 100 | 190 | 270 | | * | . * | | l | . * | . * | kHz |
| Slew Rate | G = 2 to 100 | 12 | 17 | | * | _ * | | l | * | * | V/µs |
| Settling Time: | 1/ 051151 | | | | | | | | 1 . | | |
| 0.1%, G = 1 | V _O = 20V Step | 1 | 4 | | l | * | | l | * | | μs |
| G = 10 | | | 2 | | | * | | | * | | μs |
| G = 100 | | | 3 | | | * | | | * | | μs |
| G = 200 | | 1 | 5 | | l | * | | l | * | | μs |
| | i . | | 11 | 1 | ı | 1 + | 1 | 1 | 1 - | 1 | μs |

ELECTRICAL CHARACTERISTICS (Cont)

At +25°C, $\pm V_{CC}$ 15VDC, and R_L = 2K Ω , unless otherwise specified.

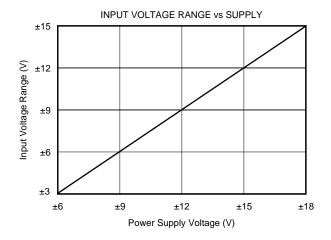
| | | | INA110AC | } | IN | A110BG, | SG | IN | A110KP, | KU | |
|-------------------------|---------------------------|-----|----------|------|-----|---------|------|-----|---------|-----|-------|
| PARAMETER | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNITS |
| DYNAMIC RESPONSE (CONT) | | | | | | | | | | | |
| Settling Time: | | | | | | | | | | | |
| 0.01%,G = 1 | V _O = 20V Step | | 5 | 12.5 | | * | * | | * | | μs |
| G = 10 | | | 3 | 7.5 | | * | * | | * | | μs |
| G = 100 | | | 4 | 7.5 | | * | * | | * | | μs |
| G = 200 | | | 7 | 12.5 | | * | * | | * | | μs |
| G = 500 | | | 16 | 25 | | * | * | | * | | μs |
| Recovery ⁽⁵⁾ | 50% Overdrive | | 1 | | | * | | | * | | μs |
| POWER SUPPLY | | | | | | | | | | | |
| Rated Voltage | | | ±15 | | | * | | | * | | V |
| Voltage Range | | ±6 | | ±18 | * | | * | * | | * | V |
| Quiescent Current | $V_O = 0V$ | | ±3 | ±4.5 | | * | * | | * | * | mA |
| TEMPERATURE RANGE | | | | | | | | | | | |
| Specification: P, U | | -25 | | +85 | * | | * | 0 | | +70 | °C |
| G | | | | | -55 | | +125 | | | | °C |
| Operation | | -55 | | +125 | * | | * | -25 | | +85 | °C |
| Storage | | -65 | | +150 | * | | * | -40 | | +85 | °C |
| $	heta_{JA}$ | | | 100 | | | * | | | * | | °C/W |

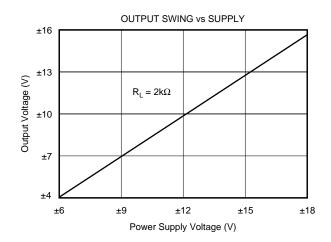
^{*} Same as INA110AG

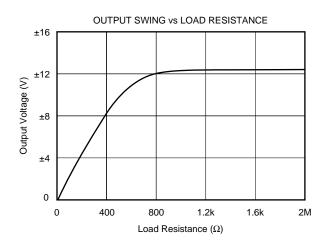
NOTES: (1) Gains other than 1, 10, 100, 200, and 500 can be set by adding an external resistor, R_G , between pin 3 and pins 11, 12 and 16. Gain accuracy is a function of R_G and the internal resistors which have a $\pm 20\%$ tolerance with 20ppm/°C drift. (2) Adjustable to zero. (3) For differential input voltage other than zero, see Typical Characteristics. (4) $V_{NOISE\,RTI} = \sqrt{V_N^2}_{INPUT} + (V_{NOUTPUT}/Gain)^2$. (5) Time required for output to return from saturation to linear operation following the removal of an input overdrive voltage.

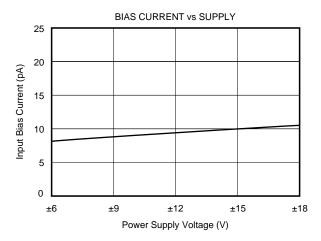
TYPICAL CHARACTERISTICS

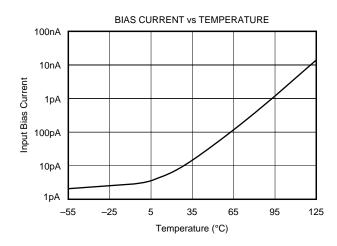
At T_A = +25°C and $\pm V_{CC}$ = 15VDC, unless otherwise noted.

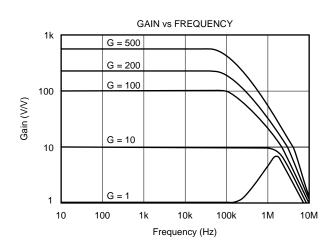










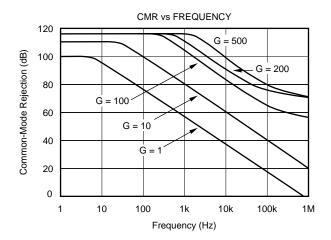


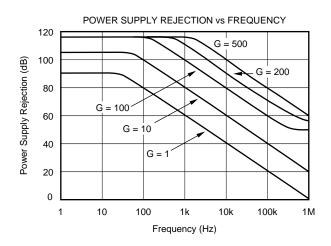


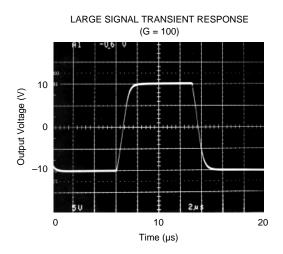


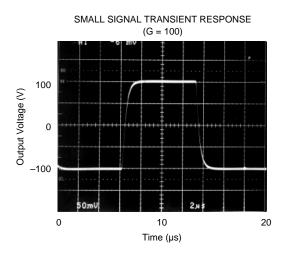
TYPICAL CHARACTERISTICS (Cont)

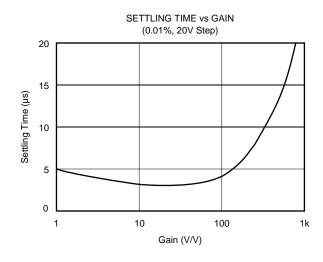
At T_A = +25°C and $\pm V_{CC}$ = 15VDC, unless otherwise noted.

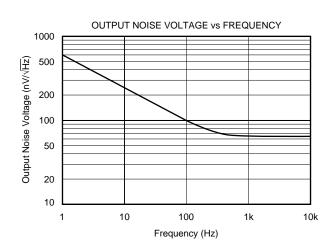








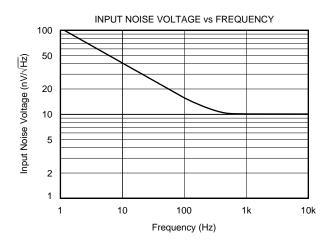


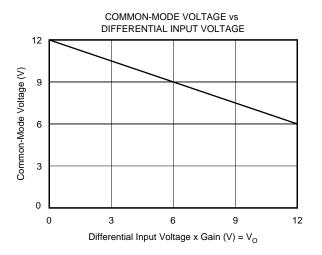


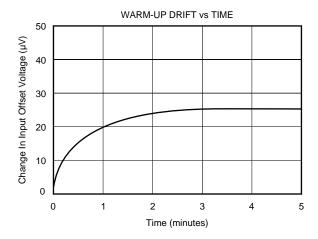


TYPICAL CHARACTERISTICS (Cont)

At T_A = +25°C and $\pm V_{CC}$ = 15VDC, unless otherwise noted.











DISCUSSION OF PERFORMANCE

A simplified diagram of the INA110 is shown on the first page. The design consists of the classical three operational amplifier configuration using current-feedback type op amps with precision FET buffers on the input. The result is an instrumentation amplifier with premium performance not normally found in integrated circuits.

The input section (A_1 and A_2) incorporates high performance, low bias current, and low drift amplifier circuitry. The amplifiers are connected in the noninverting configuration to provide high input impedance ($10^{12}\Omega$). Laser-trimming is used to achieve low offset voltage. Input cascoding assures low bias current and high CMR. Thin-film resistors on the integrated circuit provide excellent gain accuracy and temperature stability.

The output section (A_3) is connected in a unity-gain difference amplifier configuration. Precision matching of the four $10k\Omega$ resistors, especially over temperature and time, assures high common-mode rejection.

BASIC POWER SUPPLY AND SIGNAL CONNECTIONS

Figure 1 shows the proper connections for power supply and signal. Supplies should be decoupled with 1µF tantalum capacitors as close to the amplifier as possible. To avoid gain and CMR errors introduced by the external circuit, connect grounds as indicated, being sure to minimize ground resistance. Resistance in series with the reference (pin 6) will degrade CMR. To maintain stability, avoid capacitance from the output to the gain set, offset adjust, and input pins.

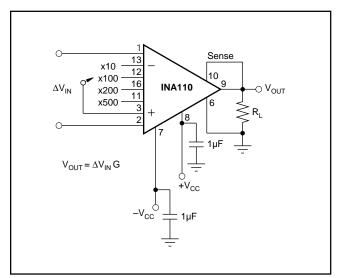


FIGURE 1. Basic Circuit Connection.

OFFSET ADJUSTMENT

Figure 2 shows the offset adjustment circuit for the INA110. Both the offset of the input stage and output stage can be adjusted separately. Notice that the offset referred to the

INA110's input (RTI) is the offset of the input stage plus the offset of the output stage divided by the gain of the input stage. This allows specification of offset independent of gain.

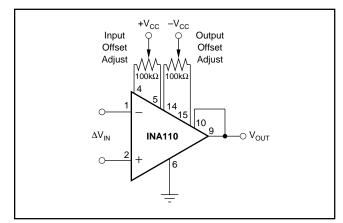


FIGURE 2. Offset Adjustment Circuit.

For systems using computer autozeroing techniques, neither offset nor offset drift are of concern. In many other applications, the factory-trimmed offset gives excellent results. When greater accuracy is desired, one adjustment is usually sufficient. In high gains (>100) adjust only the input offset, and in low gains the output offset. For higher precision in all gains, both can be adjusted by first selecting high gain and adjusting input offset and then low gain and adjusting output offset. The offset adjustment will, however, add to the drift by approximately $0.33\mu V/^{\circ}C$ per $100\mu V$ of input offset voltage that is adjusted. Therefore, care should be taken when considering use of adjustment.

Output offsetting can be accomplished as shown in Figure 3 by applying a voltage to the reference (pin 6) through a buffer. This limits the resistance in series with pin 6 to minimize CMR error. Be certain to keep this resistance low. Note that the offset error can be adjusted at this reference point with no appreciable degradation in offset drift.

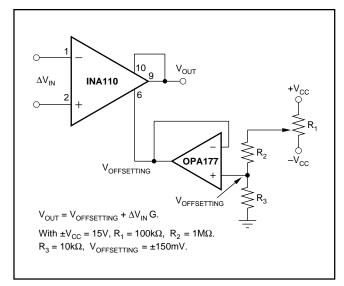


FIGURE 3. Output Offsetting.



GAIN SELECTION

Gain selection is accomplished by connecting the appropriate pins together on the INA110. Table I shows possible gains from the internal resistors. Keep the connections as short as possible to maintain accuracy.

| GAIN | CONNECT PIN 3 TO PIN | GAIN ACCURACY (%) | GAIN DRIFT (ppm/°C) | | | |
|---------------|---|----------------------|------------------------|--|--|--|
| The following | | | | | | |
| 1 | none | 0.02 | 10 | | | |
| 10 | 13 | 0.05 | 10 | | | |
| 100 | 12 | 0.1 | 20 | | | |
| 200 | 16 | 0.2 | 30 | | | |
| 500 | 11 | 0.5 | 50 | | | |
| The following | The following gains have typical accuracy as shown: | | | | | |
| 300 | 12, 16 | 0.25 | 10 | | | |
| 600 | 11, 12 | 0.25 | 40 | | | |
| 700 | 11, 16 | 2 | 40 | | | |
| 800 | 11, 12, 16 | 2 | 80 | | | |

TABLE I. Internal Gain Connections.

Gains other than 1, 10, 100, 200, and 500 can be set by adding an external resistor, R_G , between pin 3 and pins 12, 16, and 11. Gain accuracy is a function of R_G and the internal resistors which have a $\pm 20\%$ tolerance with $20\text{ppm}/^\circ\text{C}$ drift. The equation for choosing R_G is shown below.

$$R_{G} = \frac{40k\Omega}{G-1} - 50\Omega$$

Gain can also be changed in the output stage by adding resistance to the feedback loop shown in Figure 4. This is useful for increasing the total gain or reducing the input stage gain to prevent saturation of input amplifiers.

The output gain can be changed as shown in Table II. Matching of R_1 and R_3 is required to maintain high CMR. R_2 sets the gain with no effect on CMR.

| OUTPUT STAGE GAIN | R ₁ AND R ₃ | R ₂ |
|-------------------|-----------------------------------|----------------|
| 2 | 1.2kΩ | 2.74kΩ |
| 5 | 1kΩ | 511Ω |
| 10 | 1.5kΩ | 340Ω |

TABLE II. Output Stage Gain Control.

COMMON-MODE INPUT RANGE

It is important not to exceed the input amplifiers' dynamic range (see Typical Characteristics). The differential input signal and its associated common-mode voltage should not cause the output of A_1 and A_2 (input amplifiers) to exceed approximately $\pm 10 V$ with $\pm 15 V$ supplies or nonlinear operation will result. Such large common-mode voltages, when the INA110 is in high gain, can cause saturation of the input stage even though the differential input is very small. This can be avoided by reducing the input stage gain and increasing the output stage gain with an H pad attenuator (see Figure 4).

OUTPUT SENSE

An output sense has been provided to allow greater accuracy in connecting the load. By attaching this feedback point to the load at the load site, IR drops due to load currents that are eliminated since they are inside the feedback loop. Proper connection is shown in Figure 1. When more current is to be supplied, a power booster can be placed within the feedback loop as shown in Figure 5. Buffer errors are minimized by the loop gain of the output amplifier.

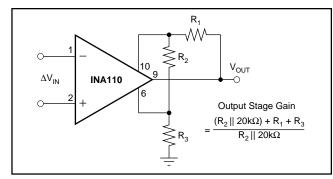


FIGURE 4. Gain Adjustment of Output Stage Using H Pad Attenuator.

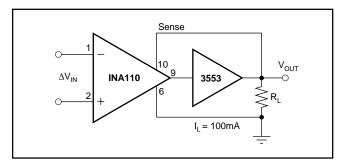


FIGURE 5. Current Boosting the Output.

LOW BIAS CURRENT OF FET INPUT ELIMINATES DC ERRORS

Because the INA110 has FET inputs, bias currents drawn through input source resistors have a negligible effect on DC accuracy. The picoamp levels produce no more than microvolts through megohm sources. Thus, input filtering and input series protection are readily achievable.

A return path for the input bias currents must always be provided to prevent charging of stray capacitance. Otherwise, the output can wander and saturate. A $1M\Omega$ to $10M\Omega$ resistor from the input to common will return floating sources such as transformers, thermocouples, and AC-coupled inputs (see Applications section).

DYNAMIC PERFORMANCE

The INA110 is a fast-settling FET input instrumentation amplifier. Therefore, careful attention to minimize stray capacitance is necessary to achieve specified performance. High source resistance will interact with input capacitance to reduce the overall bandwidth. Also, to maintain stability, avoid capacitance from the output to the gain set, offset adjust, and input pins.

Applications with balanced-source impedance will provide the best performance. In some applications, mismatched source impedances may be required. If the impedance in the negative input exceeds that in the positive input, stray capacitance from the output will create a net negative feedback and improve the circuit stability. If the impedance in the positive input is greater, the feedback due to stray capacitance will be positive and instability may result. The degree of positive feedback depends upon source impedance imbalance, operating gain, and board layout. The addition of a small bypass capacitor of 5pF to 50pF directly between the inputs of the IA will generally eliminate any positive feedback. CMR errors due to the input impedance mismatch will also be reduced by the capacitor.

The INA110 is designed for fast settling with easy gain selection. It has especially excellent settling in high gain. It can also be used in fast-settling unity-gain applications. As with all such amplifiers, the INA110 does exhibit significant gain peaking when set to a gain of 1. It is, however, unconditionally stable. The gain peaking can be cancelled by band-limiting the negative input to 400kHz with a simple external RC circuit for applications requiring flat response. CMR is not affected by the addition of the 400kHz RC in a gain of 1.

Another distinct advantage of the INA110 is the high frequency CMR response. High frequency noise and sharp common-mode transients will be rejected. To preserve AC CMR, be sure to minimize stray capacitance on the input lines. Matching the RCs in the two inputs will help to maintain high AC CMR.

APPLICATIONS

In addition to general purpose uses, the INA110 is designed to accurately handle two important and demanding applications: (1) inputs with high source impedances such as capacitance/crystal/photodetector sensors and low-pass filters and series-input protection devices, and (2) rapid-scanning data acquisition systems requiring fast settling time. Because the user has access to the output sense, current sources can also be constructed using a minimum of external components. Figures 6 through 19 show application circuits.

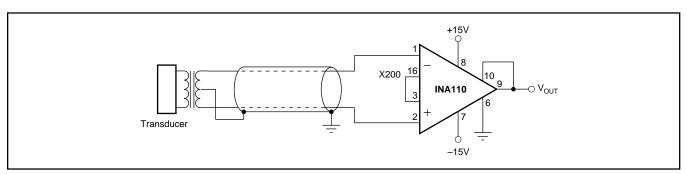


FIGURE 6. Transformer-Coupled Amplifier.

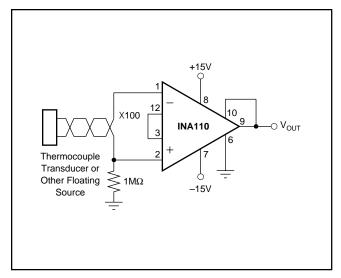


FIGURE 7. Floating Source Instrumentation Amplifier.

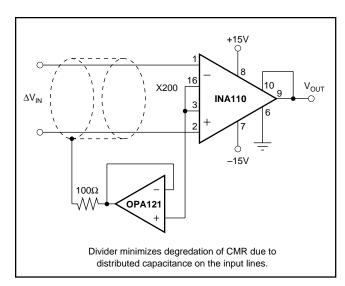


FIGURE 8. Instrumentation Amplifier with Shield Driver.

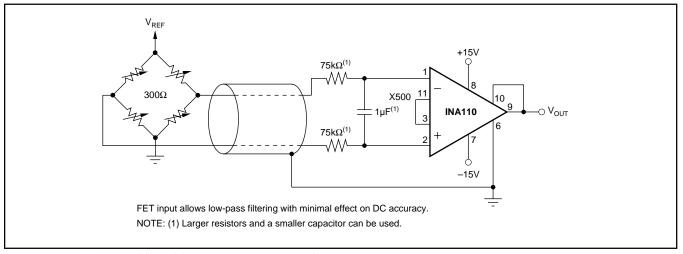


FIGURE 9. Bridge Amplifier with 1Hz Low-Pass Input Filter.

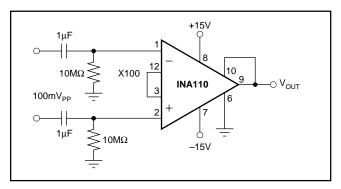


FIGURE 10. AC-Coupled Differential Amplifier for Frequencies Greater Than 0.016Hz.

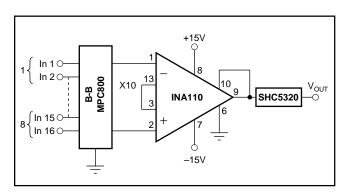


FIGURE 12. Rapid-Scanning-Rate Data Acquisition Channel with 5µs Settling to 0.01%.

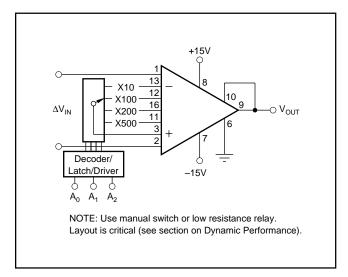


FIGURE 11. Programmable-Gain Instrumentation Amplifier (Precision Noninverting or Inverting Buffer with Gain).

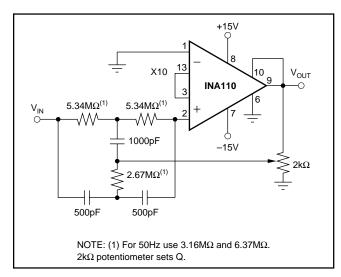


FIGURE 13. 60Hz Input Notch Filter.

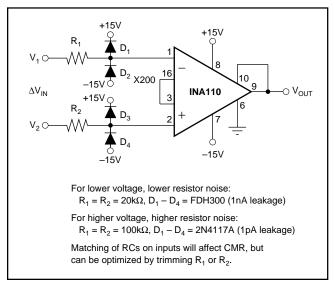


FIGURE 14. Input-Protected Instrumentation Amplifier.

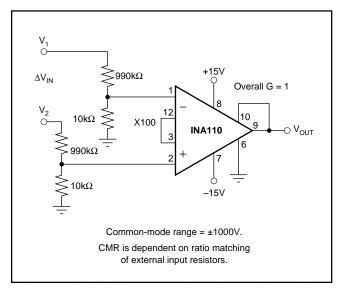


FIGURE 15. High Common-Mode Voltage Differential Amplifier.

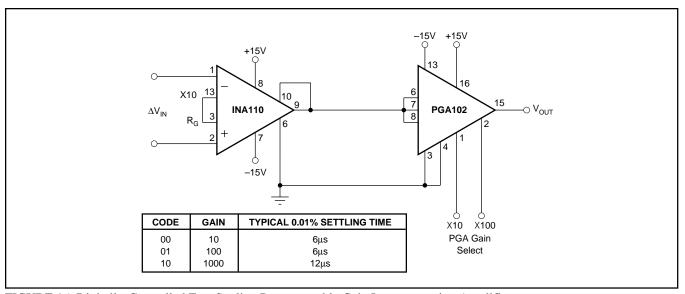


FIGURE 16. Digitally-Controlled Fast-Settling Programmable Gain Instrumentation Amplifier.

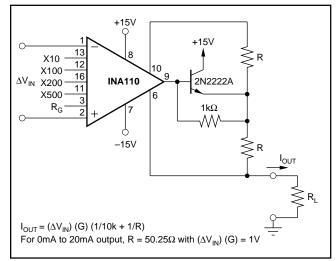


FIGURE 17. Differential Input FET Buffered Current Source.

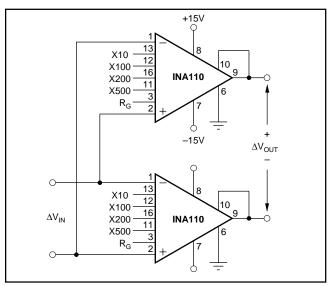


FIGURE 18. Differential Input/Differential Output Amplifier.







i.com 28-Nov-2005

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| INA110AG | NRND | ZZ (BB) | ZZ109 | 16 | | TBD | Call TI | Call TI |
| INA110KP | ACTIVE | PDIP | N | 16 | 25 | TBD | Call TI | Level-NA-NA-NA |
| INA110KU | ACTIVE | SOIC | DW | 16 | 48 | TBD | CU NIPDAU | Level-2-220C-1 YEAR |
| INA110SG | NRND | CDIP SB | JD | 16 | 24 | Green (RoHS & no Sb/Br) | Call TI | Level-NC-NC-NC |
| INA110SG1 | OBSOLETE | TO-100 | LME | 10 | | TBD | Call TI | Call TI |
| INA110SG2 | OBSOLETE | TO-100 | LME | 10 | | TBD | Call TI | Call TI |

 $^{(1)}$ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

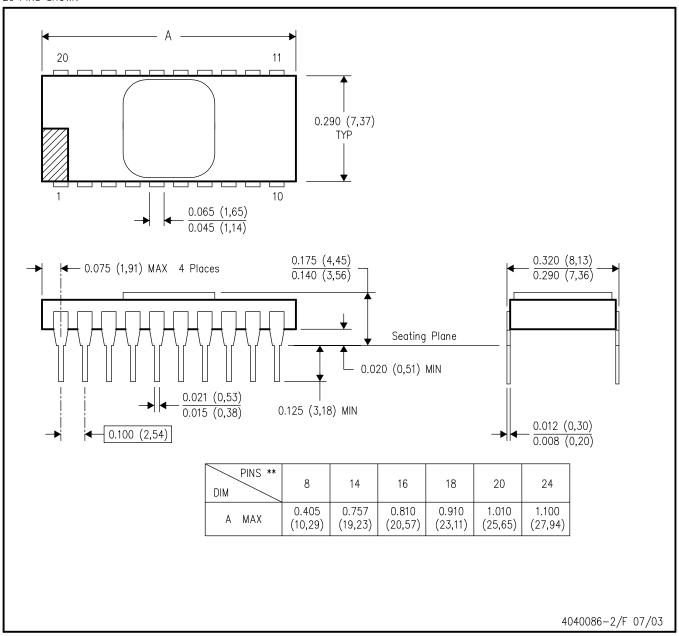
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JD (R-CDIP-T**)

CERAMIC SIDE-BRAZE DUAL-IN-LINE PACKAGE

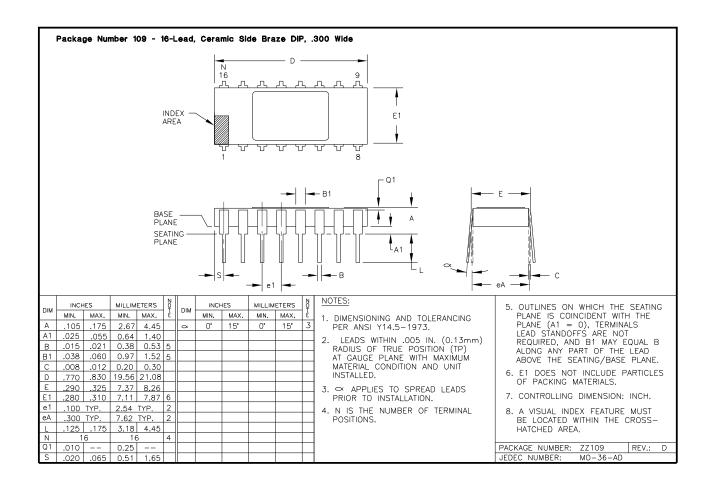
20 PINS SHOWN



NOTES:

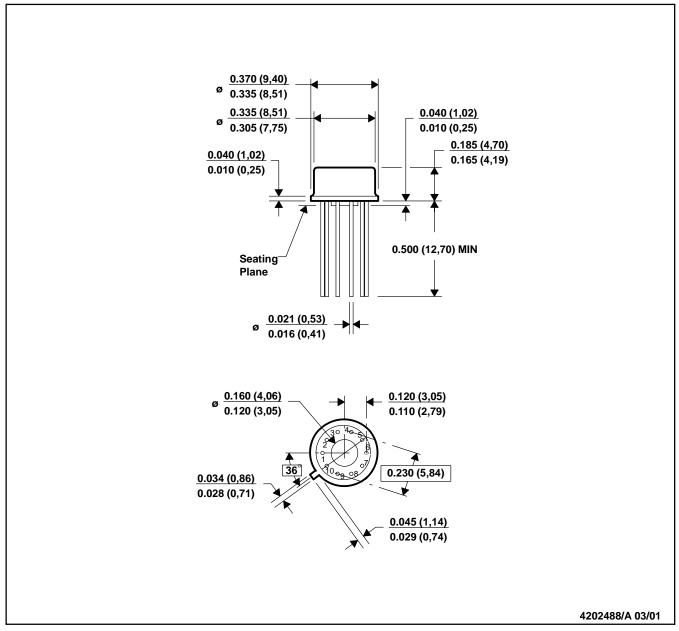
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within MIL STD 1835 CDIP2 T8, T14, T16, T18, T20 and T24 respectively.





LME (O-MBCY-W10)

METAL CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Leads in true position within 0.010 (0,25) R @ MMC at seating plane.
- D. Pin numbers shown for reference only. Numbers may not be marked on package.
- E. Falls within JEDEC MO-006/TO-100.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AA.



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